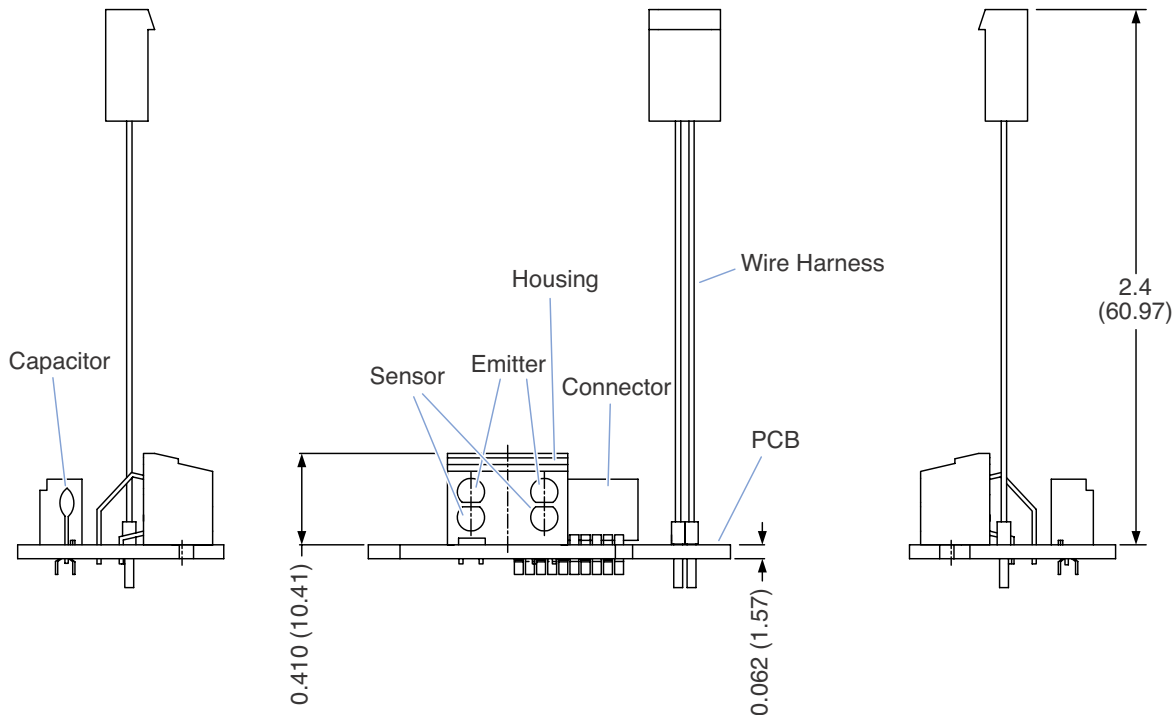
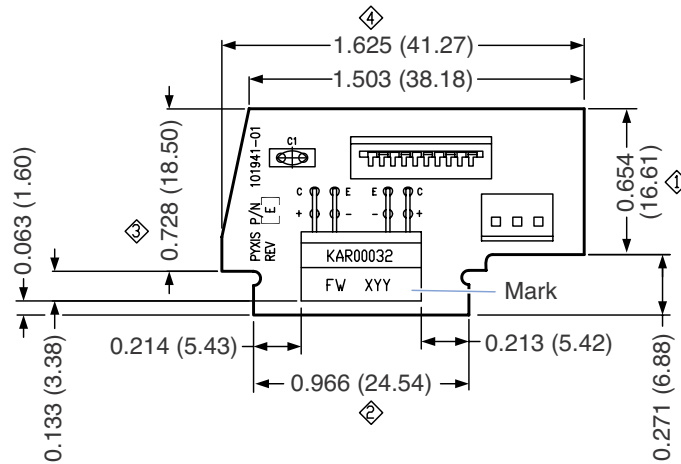


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REVISIONS

NO.	DESCRIPTION	DATE	NAME/SITE
A	ORIGINATION	10OCTOBER11	—



Dimensions: inches (mm)

Notes:

- Test finished product according to KAR00032 QTID.
- Mark approximately where shown with FCS part number "KAR00032", FSC logo, assembly plant code (W), and 3 digit date code (year X and week YY). Use white ink, Helvetica or Arial minimum 0.06" high. Laser marking is acceptable.
- ◇ denotes critical dimension.
- Reflector, use Kodak paper 90% reflectivity white side, and 10% reflectivity gray side.
- All exterior surface shall be free of scratches, pits, burrs, and any foreign materials.
- Full IR device insertion with proper tool that does not stress the leadframe/epoxy interface.
- Gap between PCB and housing 0.01" maximum.

APPROVALS	DATE	FAIRCHILD SEMICONDUCTOR®		
DRAWN: D. LEISER				
CHECKED: JH. PARK		KAR00032		
APPROVED: T. HERNOULT				
PROJECTION INCH (MM)		SCALE 1:1	SIZE N/A	DRAWING NUMBER MKT-AC000A
		FORMERLY: N/A	REV 0	

SHEET: 1 OF 1